

Liquid Crystal Polymer (LCP): A new organic material for the development of multilayer dual frequency/ dual polarization flexible antenna arrays

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Abstract— The development of dual-frequency (14 GHz and 35 GHz), dual-polarization microstrip antenna arrays is presented for the first time on Liquid Crystal Polymer (LCP) multilayer technology. Some of the properties of LCP such as multilayer (3D) vertical integration capability, good electrical and mechanical properties, near-hermetic nature make this substrate a practical choice for the design of low-cost antenna arrays that can be integrated with remote sensing applications operating in the Ku and millimeter-wave frequency bands. This work illustrates the potential of LCP as a low-cost, 'all-package' solution for developing compact, flexible, antenna arrays that can be used in future communication and remote sensing systems.

Index Terms— Liquid Crystal Polymer, Multilayer fabrication, Microstrip Antenna Array, Dual frequency/ polarization

I. INTRODUCTION

MANY radar and communication systems need antennas with dual-polarization and dual frequency capabilities for higher capacity data transfer. Microstrip patch antennas are often desirable antenna elements in such applications due to their low cost, low profile, light weight, and ease of fabrication characteristics [1]. In recent years, there has been much research done in the field of designing dual-frequency and dual-polarization microstrip antenna arrays [2]- [5].

When designing dual-frequency, dual polarized microstrip antenna arrays, one has to confront many parameters of interest and the associated complexity both in design and fabrication. There is a need for a complex feeding structure that minimizes interconnect loss, feedline radiation and cross-coupling [6]. Substrate thickness can affect cross-polarization levels as well as bandwidth and efficiency. The distance of the antenna elements in the array can affect -3 dB beamwidth, directivity and side-lobe levels besides impacting the overall size. Careful consideration needs to be given to avoid cross-coupling between the antenna arrays operating at different frequencies, blockage effects and edge diffraction [7]. It is almost impossible to achieve all the aforementioned performance with a single layer structure. A multilayer architecture is required that can also result in very compact implementations. One such design of a dual-frequency, dual-polarized microstrip antenna array incorporating vertical integration was proposed by Granholm and Skou [8]. This design consists of C-band and

L-band patches operating at 1.25 and 5.3 GHz, respectively, on the metal layers separated by substrate layers of three distinct dielectric media including foam.

Although there have been many reported examples of dual-frequency, dual polarization microstrip antenna arrays on substrates, such as Duroid, these designs are not always favorable for a radio frequency (RF) system-on-a-package (SOP) low-cost technology due to various undesirable substrate properties. Materials, like Duroid, are often used in conjunction with low dielectric constant foam to realize multilayer configurations. Such composite multilayer structures are subjected to greater stress due to CTE mismatches, which can alter the dimensions of the structure. There are many other thermal and mechanical problems inherent in such a multilayer design formed by integrating different materials. In order to overcome these problems and to integrate switches and phase shifters to enhance the reconfigurability, thus taking full advantage of polarization diversity and beam scanning capabilities, there is a need for a laminated substrate that has vertical integration capabilities and is suitable for packaging RF passive and active components and embedded functions.

Liquid crystal polymer (LCP) offers such an unique combination of properties. This material has gained much consideration as a potential high performance microwave substrate and packaging material recently [9]- [11]. Its low dielectric constant and low loss tangent [12] in tandem with low water absorption coefficient [13] and low cost make it a first choice material for developing multilayer antenna arrays. Additionally its Coefficient of Thermal Expansion (CTE) can be adjusted through thermal treatments, facilitating integration of IC's in SOP modules. Furthermore LCP, being a flexible material, leads to convenient deployment of antennas in space. Large sheets of LCP containing antenna arrays can be flexed, rolled up and easily deployed.

This paper presents for the first time, the design, fabrication and measurement of dual-frequency (14 GHz and 35 GHz), microstrip antenna arrays with dual-polarization capabilities excited separately at each frequency on flexible LCP multilayer substrates. These designs can eventually be applied to the remote sensing of precipitation at 14 and 35 GHz. They can be extended by integrating RF MEMS switches [14] with the antenna arrays to switch polarizations introducing the possibility of a low-power reconfigurable antenna array design. Full-wave simulations of the antenna array designs were performed and validated with good agreement of measured results of scattering parameters and radiation patterns.

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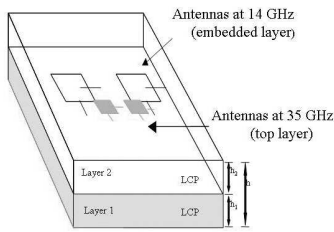


Fig. 1. Multilayer Antenna Array Architecture; $h_1 = 8\text{mils}$, $h_2 = 9\text{mils}$, $h = 17\text{mils}$

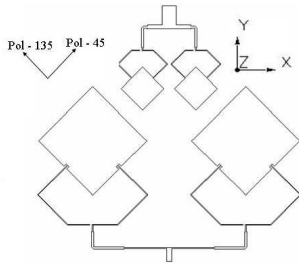


Fig. 2. Top View - Symmetrically-fed Array

II. ARRAY DESIGN

The generic multilayer architecture of the dual-polarization, dual-frequency microstrip antenna array at 14 and 35 GHz is shown in Fig. 1. The total substrate thickness (h) for the design is 17 mils, consisting of two LCP layers (each 8 mils thick) and a 1 mil bonding layer. The 14 GHz antenna array is embedded on an 8 mil layer (h_1) while the 35 GHz patches that are physically smaller are placed on the top layer (at the interface of LCP and air) to minimize blockage of the 14 GHz radiation. The particular choice of substrate thicknesses stemmed from extensive analysis of their influence on cross-polarization levels, bandwidth and efficiency at each frequency. The feed network for each array was placed in the same layer as the radiating elements. This configuration was chosen ahead of many other configurations, including aperture coupled and proximity coupled feeding, to minimize computational and fabrication complexity.

The top view of the dual - frequency antenna array with diagonal patch elements is shown in Fig. 2. This particular design is intended for precipitation radar systems wherein similar characteristics for orthogonal polarizations and polarization purity are of utmost importance, no matter what frequency band is used [15]. As shown in the figure, the patches are rotated by 45° and the polarization directions are at 45° and 135° as opposed to the traditional x-y directions. This arrangement helps in realizing a symmetrical feed network for both polarizations with similar impedance and radiation pattern characteristics. As a first modeling step, the switching of polarizations is controlled by the presence of "hard-wired" perfect "short" and "open" conditions. In a practical implementation, RF MEMS switches will be used to switch polarizations and steer the main beam. To simplify the antenna structure, the design approach uses an unloaded $200\ \mu\text{m}$ gap to simulate an "OFF" state and a continuous feedline to simulate an "ON" state. In order to minimize the radiation

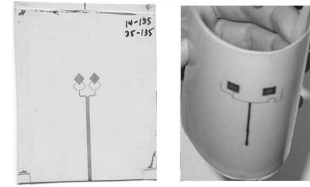


Fig. 3. Photo of the fabricated symmetrically-fed Array & Photo demonstrating flexibility

effects of the feed lines, the lines that directly connect to the radiating element are made as thin as possible. A recessed patch feed and a combination of T-junctions and quarter wave transformers are employed to achieve better matching and a symmetric feed structure is used to expand into a 2×1 array. EmPicasso, a MOM (method of moments) based frequency domain full-wave solver, was used for design and simulations.

III. FABRICATION /MEASUREMENT SETUP

The antenna arrays were fabricated with two copper-clad 8 mil LCP dielectric sheets and one 1 mil LCP adhesion layer from Rogers Corporation. Although a thick copper layer may restrict the minimum feature size due to undercut problems, it is difficult to sputter/ electroplate thin layers of copper on LCP reliably because it has a low stiction coefficient to copper. Therefore thick copper cladding is used and the etch process was characterized and the patterns are modified beforehand to compensate for the undercut. **The undercut, if not compensated, can alter critical dimensions of the array, such as the patch length and width, besides impacting the impedance of the feedlines. This can cause undesirable shifts in the resonant frequency of the array especially at 35 GHz. An alternative to using thick copper would be to introduce a thin buffer layer such as titanium between copper and LCP to improve stiction.** Shipley 1827 photoresist was used for pattern definition and the arrays are exposed under 16,000 dpi mask transparencies pressed into sample contact with 5" glass mask plates. Photoresist development and a wet chemical etch with ferric chloride were then performed to complete the antenna patterning. The LCP layers with the 14 GHz and the 35 GHz array were then bonded together in a Karl Suss SB-6 silicon wafer bonder using a 1 mil low melt LCP bond layer sandwiched between the two 8 mil high melt LCP core layers. The bond layer melts at a lower temperature than the core layers and its flow coupled with the tool pressure applied between the core layers results in the realization of multilayer LCP structures. This is the most critical step in the fabrication process and has to be understood thoroughly to create multilayer LCP structures reliably. Several experiments were carried out to optimize the temperature and the tool pressure to achieve good bonding while preventing shrinkage, formation of bubbles and melting of core layers. **The bubbles can result in air gaps that can affect the array performance at mm-wave frequencies.** Photographs of 2×1 antenna arrays on LCP showing the flexibility of the substrate are shown in Fig 3.

The array was mounted on an aluminum fixture that included a 2.4 mm coaxial-to-microstrip connector to measure

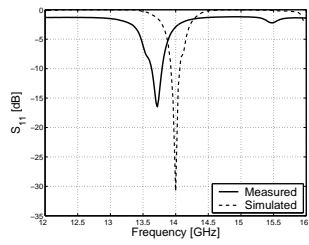


Fig. 4. Return Loss - 14 GHz Array

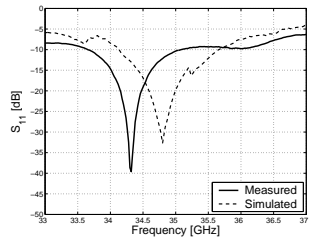


Fig. 5. Return Loss - 35 GHz Array

the return loss of the array. A short, open, load, and thru (SOLT) [16] calibration was performed on a vector network analyzer with the reference planes at the end of the coaxial cables. When required, the microstrip launcher was adjusted to improve the Antenna Under Test (AUT) to coaxial launcher impedance match. An anechoic chamber with the AUT as the receive element and a 15 dB gain horn antenna as the transmitting antenna was used for radiation pattern measurements. The AUT was rotated through the measurement plane, and the entire system, including the data recording, was automated. Because the microstrip launcher and the absorbing material placed around it covered a portion of the plane during the scan, there was a slight asymmetry in the radiation patterns due to the characterization system. In addition, the absorber affected the radiation pattern at scan angles greater than 70° off boresight.

IV. RESULTS

The simulated and measured return loss plots versus frequency are shown in Figs. 4 (at 14 GHz) and 5 (at 35 GHz). The results are for the 135° polarization though they are the same for the 45° polarization also owing to the symmetric arrangement. The dual-frequency array was excited at one frequency, while the other array was treated as a parasitic element. The results are summarized in Tables 1 and 2. The shift in the resonant frequency can be attributed to fabrication tolerances. The discrepancy in return loss at 14 GHz is due to the extension of the feedline of the embedded (14 GHz) antenna to a point where the top laminated layer of the substrate no longer covers the feedline, thus, modifying its characteristic impedance. The measured impedance bandwidths at both frequencies are in good agreement with those of the simulated designs.

Additionally, the simulated and measured 2D radiation patterns are shown in Figs. 6 and 7 for the E- and H-plane at 14 GHz respectively and Figs. 8 and 9 for the E- and H-plane at 35 GHz respectively. The results are summarized in

TABLE I
RETURN LOSS CHARACTERISTICS OF THE 14 GHz ARRAY

Characteristic	Simulated 14-135	Measured 14-135
Resonant Frequency	14 GHz	13.72 GHz
Return Loss	-30.7 dB	-16.5 dB
-10 dB Return Loss Bandwidth	140 MHz	160 MHz
Percent Bandwidth	1.00%	1.17%

TABLE II
RETURN LOSS CHARACTERISTICS OF THE 35 GHz ARRAY

Characteristic	Simulated 35-135	Measured 35-135
Resonant Frequency	34.87 GHz	34.32 GHz
Return Loss	-32.5 dB	-39.6 dB
-10 dB Return Loss Bandwidth	1560 MHz	1530 MHz
Percent Bandwidth	4.47%	4.46%

Tables 3 and 4. The E-plane and H-plane beamwidths and the shapes of the co-polarized patterns are consistent for both the simulated and measured patterns of the 14 GHz array which is expected for a symmetric configuration. The center-to-center distance can be increased to reduce the E-plane beamwidth to a value close to the H-plane beamwidth, but side-lobes will start to form as a result of this increase. The measured cross polarization levels also agree well with the predicted values for scan angles less than 70°. The discrepancy at angles above 70° is due to the presence of the absorber as explained in the measurement section. In addition, it has been noted in [1] and [17] that the cross-polarization level tends to increase as the substrate thickness increases. Therefore, the higher frequency (35 GHz) antenna array on the electrically thicker substrate exhibits a worse cross-polarization level than the lower frequency (14 GHz) array on the electrically thinner substrate. An improved design would place the 35 GHz patches on a thinner (e.g. 4 mil) LCP substrate. To demonstrate the flexibility and mechanical stability of the multilayer LCP substrate, which is important for deployable antennas, antenna arrays were flexed several times and recharacterized. The return loss and radiation patterns were unchanged within the repeatability of the measurement equipment.

V. CONCLUSION

A dual-frequency (14 GHz and 35 GHz), microstrip antenna array with dual-polarization capabilities excited separately at each frequency for SOP RF front-ends have been presented for the first time on flexible LCP multilayer substrate. The

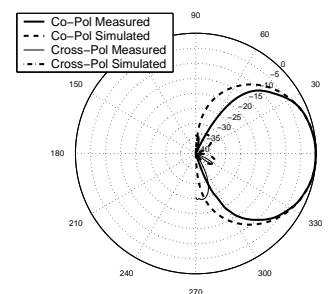


Fig. 6. E-plane Radiation Pattern - 14 GHz Array

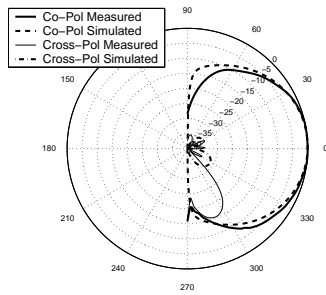


Fig. 7. H-plane Radiation Pattern - 14 GHz Array

TABLE III

RADIATION PATTERN CHARACTERISTICS OF THE 14 GHz ARRAY

Characteristic	Simulated 14-135	Measured 14-135
E-Plane -3 dB Beamwidth	65°	67°
H-Plane -3 dB Beamwidth	58°	58°
Max. Cross-pol.(E-plane)	-31 dB	-25 dB
Max. Cross-pol.(H-plane)	-33 dB	-30 dB

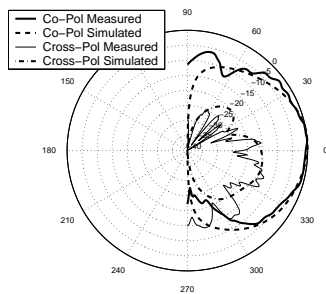


Fig. 8. E-plane Radiation Pattern - 35 GHz Array

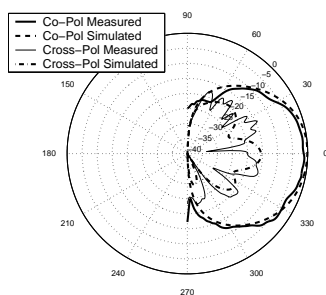


Fig. 9. H-plane Radiation Pattern - 35 GHz Array

TABLE IV

RADIATION PATTERN CHARACTERISTICS OF THE 35 GHz ARRAY

Characteristic	Simulated 35-135	Measured 35-135
E-Plane -3 dB Beamwidth	65°	66°
H-Plane -3 dB Beamwidth	59°	59°
Max. Cross-pol.(E-plane)	-15 dB	-14 dB
Max. Cross-pol.(H-plane)	-16 dB	-15 dB

arrays exhibit a return loss of better than 15 dB in both frequency bands. The measured beamwidths were also in good agreement with the simulated results. The measured cross-polarization levels are higher than the predicted ones but can be improved by introducing a separate feed layer. The results shown here demonstrate the applicability of LCP for the development of low cost, lightweight, and low power RF front ends and antennas on an "all-package" solution for future communication and remote sensing systems operating up to mm-wave frequency ranges.

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